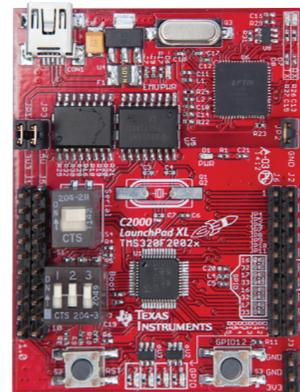
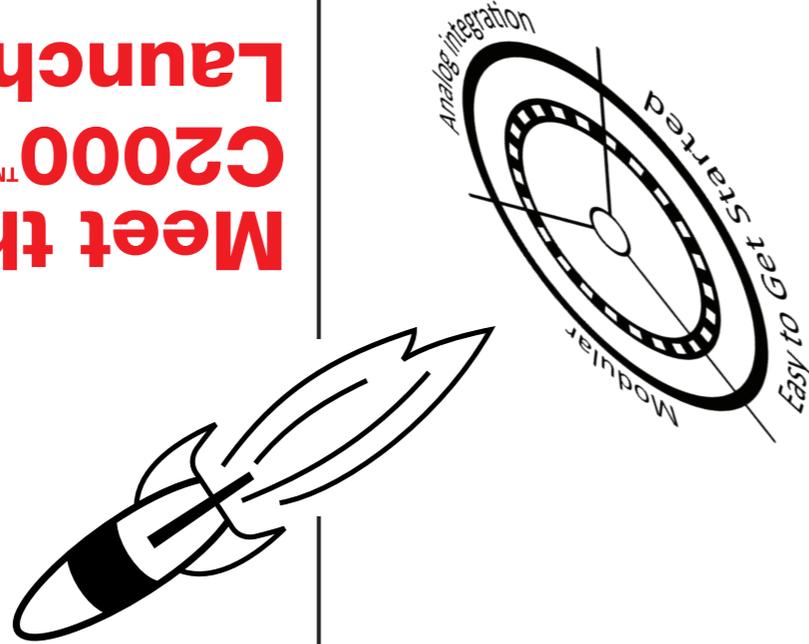


Meet the C2000™ Piccolo™ LaunchPad



- Everything needed to get started in one package
- Rapid prototyping with double-sided headers, buttons, LEDs, and much more
- On-board isolated JTAG emulation
- Software examples in controlSUITE software

Additional resources @ www.ti.com/c2000-launchpad

C2000™ Piccolo™ LaunchPad Quick Start Guide: LAUNCHXL-F28027

Meet the C2000 Piccolo LaunchPad evaluation kit based on the F28027 device. The LaunchPad is a complete USB-based evaluation kit and educational tool providing everything you need to start your system evaluation and development.

1. Software and driver installation

Go to www.ti.com/c2000-launchpad. Here, you can download a free version of TI's integrated development environment: Code Composer Studio™ (CCS) IDE version 5. Installing CCS will install the necessary drivers for the LaunchPad. You will also need to download the controlSUITE™ software package for the LaunchPad which is available here as well.



2. Connecting the hardware

Connect the C2000 Piccolo LaunchPad using the included USB cable to your PC. If prompted to install driver, let the driver install wizard complete with the default settings. After the drivers have been installed, ensure that jumpers are placed on JP1, JP2 and JP3.

3. The demo application – internal temperature measurement

The C2000 Piccolo LaunchPad has a pre-programmed Piccolo F28027 device. When S1 (Boot selection switch) is configured Up-Up-Down, the board will automatically boot from flash memory and start an LED toggle sequence. Pressing S3 will start the internal temperature measurement mode.

When this mode is entered, the device's internal temperature sensor is sampled to establish a reference temperature and GPIO3 LED is lit in the nibble wide LED display (8 in hexadecimal). Any increase or decrease in temperature is displayed as an increment or decrement of this binary display. In addition to this binary LED display, the temperature information is also sent to the PC via the XDS100's integrated USB-<->UART channel. To view the serial data, ensure that S4 is in the up position and open a terminal to the LaunchPad COM port at 115200 baud and 8 bits, no parity, and 1 stop bit. The serial information looks best when viewed with Putty, but any serial terminal application will work.



IMPORTANT NOTE: If S1 position 3 is left down, the emulator will not connect to the target device. To resolve simply flip this switch to the up position and reconnect.

4. Try out an example application

The controlSUITE software package for the C2000 LaunchPad contains peripheral drivers as well as numerous code examples for the LaunchPad and supported BoosterPacks. controlSUITE is accessible through CCS v5's resource explorer. Navigate to the controlSUITE within resource explorer and expand this entry. Under the kits section, look for the C2000 Launchpad: LAUNCHXL-F28027 and expand this. There you will find examples and documentation for the C2000 LaunchPad. Select a project and follow the steps presented to import, build, and debug your code on the C2000 LaunchPad. You can download the latest version of controlSUITE at www.ti.com/c2000-launchpad.

5. Develop your own application and change the world!

The possible applications of this kit are only limited by your imagination, so brew some coffee or tea and get to creating the next big "thing". Make a copy of an example project and modify it until your application is developed. Support for the C2000 Piccolo LaunchPad is available through TI's e2e forums: www.ti.com/e2e

LAUNCHXL-F28027 C2000 Piccolo LaunchPad Experimenter Kit

User's Guide



Literature Number: SPRUHH2
July 2012

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LAUNCHXL-F28027 C2000 Piccolo LaunchPad Experimenter Kit

1 LAUNCHXL-F28027 Overview

1.1 Overview

The C2000™ Piccolo™ LaunchPad™, LAUNCHXL-F28027, is a complete low-cost experimenter board for the Texas Instruments Piccolo F2802x devices. The LAUNCHXL-F28027 kit features all the hardware and software necessary to develop applications based on the F2802x microprocessor. The LaunchPad is based on the superset F28027 device, and easily allows users to migrate to lower cost F2802x devices once the design needs are known. It offers an on-board JTAG emulation tool allowing direct interface to a PC for easy programming, debugging, and evaluation. In addition to JTAG emulation, the USB interface provides a UART serial connection from the F2802x device to the host PC.

Users can download an unrestricted version of Code Composer Studio™ IDE version 5 to write, download, and debug applications on the LAUNCHXL-F28027 board. The debugger is unobtrusive, allowing the user to run an application at full speed with hardware breakpoints and single stepping available while consuming no extra hardware resources.

As shown in [Figure 1](#), the LAUNCHXL-F28027 C2000 LaunchPad features include:

- USB debugging and programming interface via a high-speed galvanically isolated XDS100v2 emulator featuring a USB/UART connection.
- Superset F28027 device which allows applications to easily migrate to lower cost devices.
- Nibble (4-bit) wide LED display.
- Two push buttons for user feedback and device reset.
- Easily accessible device pins for debugging purposes or as sockets for adding customized extension boards.
- Boot selection and USB and UART disconnect switches.

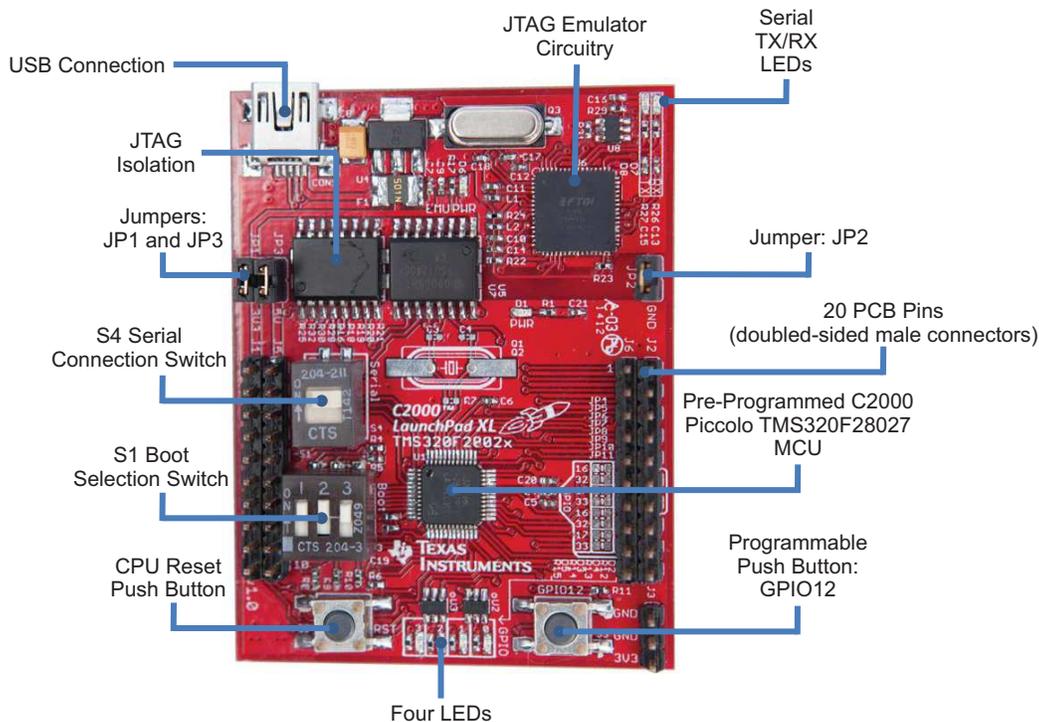


Figure 1. LAUNCHXL-F28027 Board Overview

1.2 Kit Contents

The LAUNCHXL-F28027 C2000 LaunchPad experimenter kit includes the following items:

- C2000 LaunchPad Board (LAUNCHXL-F28027)
- Mini USB-B Cable, 0.5m
- Quick Start Guide

1.3 Revisions

The first production revision of the LAUNCHXL-F28027 C2000 Piccolo LaunchPad, version 1.0, was released in July of 2012 and is currently the only revision available.

2 Installation

The C2000 LaunchPad installation consists of three easy steps:

1. Download Code Composer Studio and controlSUITE™.
2. Install Code Composer Studio and controlSUITE.
3. Connect and install the C2000 LaunchPad to the PC.

Now the LaunchPad is ready to develop applications or run the pre-programmed demo.

2.1 Download the Required Software

Code Composer Studio IDE is available for free without any restriction when used with the XDS100 emulator on the C2000 LaunchPad. The software can be downloaded from the C2000 LaunchPad page at www.ti.com/c2000-launchpad. At this site, you can also download a copy of controlSUITE that includes drivers, examples, and other support software needed to get started.

2.2 Install the Software

Once downloaded, install Code Composer Studio and the controlSUITE package.

2.3 Install the Hardware

After Code Composer Studio is installed, plug the supplied USB cable into the C2000 LaunchPad board and into an available USB port on your computer.

Windows® will automatically detect the hardware and ask you to install software drivers. Let Windows run a search for the drivers and automatically install them. After Windows successfully installs the drivers for the integrated XDS100v2 emulator, your LaunchPad is now ready for use.

3 Getting Started with the LAUNCHXL-F28027

3.1 Getting Started

The first time the LAUNCHXL-F28027 is used, a demo application automatically starts when the board is powered from a USB host. If your board does not start the demo application, try placing S1 in the following positions and resetting the board: UP - UP - DOWN. To start the demo, connect the LAUNCHXL-F28027 with the included mini-USB cable to a free USB port. The demo application starts with the LEDs flashing to show the device is active.

3.2 Demo Application, Internal Temperature Measurement

The LAUNCHXL-F28027 includes a pre-programmed TMS320F28027 device. When the LaunchPad is connected via USB, the demo starts with an LED flash sequence that points toward S3. Press S3 to start the temperature measurement mode.

A reference temperature is taken at the beginning of this mode and the LEDs of the LaunchPad are used to display any difference between the current temperature and the reference temperature. Initially, the LED connected to GPIO3 is lit to indicate an 8 in binary, which corresponds to the current temperature being equal to the reference temperature. As the temperature drifts away from the reference, the difference is displayed as a binary increment or decrement of the nibble wide LED display. For instance, if the reference temperature was 30°C and the current temperature is 33°C, the LEDs would be (from left to right) ON, OFF, ON, and ON which would be 11 in binary ($33-30=3$ and $11-8=3$). A new reference temperature may be set at any time by pressing S3 again.

In addition to the LED display, temperature information is also displayed on your PC through the USB/UART connection. To view the UART information on your PC, first figure out the COM port associated with the LaunchPad. To do this in Windows, right click on *My Computer* and click on *Properties*. In the dialog box that appears, click on the Hardware tab and open *Device Manager*. Look for an entry under Ports (COM & LPT) titled "USB Serial Port (COMX)", where X is a number. Remember this number for when you open a serial terminal. The demo applications UART data was written and debugged using PuTTY, and for the best user experience we recommend you use PuTTY to view the UART data. Open your serial terminal program and open the COM port you found previously in device manager with the following settings: 115200 Baud, 8 data bits, no parity, 1 stop bit. After opening the serial port in your serial terminal, reset the Launchpad with the reset push button and observe the serial terminal for a surprise.

3.3 Program and Debug the Temperature Measurement Demo Application

The project and associated source code for the C2000 Piccolo LaunchPad demo is included in the controlSUITE software package and should automatically be found by the TI Resource Explorer in Code Composer Studio v5. In the resource explorer, open the controlSUITE folder and then the kits tab and look for the C2000 LaunchPad line item. Expand this item and select the LaunchPad Demo Application. Follow the steps in the main pane of the resource explorer to import, build, debug, and run this application.

4 Hardware Configuration

The C2000 LaunchPad gives users several options as to how to configure the board.

4.1 Power Domain

The C2000 LaunchPad has two separate power domains for the purpose of allowing JTAG isolation. Jumpers JP1, JP2, and JP3 configure whether the USB power is passed to the target device.

Jumper	Power Domain
JP1	3.3 V
JP2	Ground
JP3	5 V

4.2 Serial Connectivity

The LAUNCHXL-F28027 has a USB to UART adapter built in. This makes it easy to print debug information back to the host PC even in isolated environments. However, in some cases the user may wish to connect the Piccolo SCI peripheral (C2000 UART peripheral) to a BoosterPack or other hardware via the header pins. If the SCI pins are connected to both the header pins, the XDS100 UART channel contention would exist and the pins would not be driven to the correct voltage levels. To solve this issue we have included a switch to allow the user to disconnect the Piccolo serial pins from the XDS100 UART connection. When S4 is in the up position, the Piccolo device's SCI is connected to the XDS100 and you are able to receive and send serial information from or to the board. When S4 is in the down position, the Piccolo device's SCI is disconnected from the XDS100 and BoosterPacks, which use serial communication, and can communicate with the Piccolo device.

4.3 Boot Mode Selection

The LaunchPad's F28027 device includes a boot ROM that performs some basic start-up checks and allows for the device to boot in many different ways. Most users will either want to perform an emulation boot or a boot to flash (if they are running the application standalone). S1 has been provided to allow users to easily configure the pins that the bootROM checks to make this decision. The switches on S1 correspond to:

Switch	Function
1	GPIO34
2	GPIO37
3	TRSTn

Keep in mind that the debugger does not connect if the device is not in the emulation boot mode (TRST switch in the up position). More information about boot mode selection can be found in the *TMS320x2802x Piccolo Boot ROM Reference Guide* ([SPRUJFN6](#)).

4.4 Connecting a Crystal

Although the Piccolo device present on the LAUNCHXL-F28027 has an internal oscillator — and for most applications this is sufficient — the LaunchPad offers a footprint for surface mount or through-hole HC-49 crystals for users who require a more precise clock. If you wish to use an external crystal, solder the crystal to the Q1/Q2 footprint and appropriate load capacitors to the C3 and C4 footprints. You also need to configure the device to use the external oscillator in software.

4.5 Connecting a Satellite Board

The C2000 LaunchPad is the perfect experimenter board to start hardware development with the F2802x devices. Connectors J1, J2, J5, and J6 and the power supply at J3 are aligned in a 0.1-in (2.54-mm) grid to allow an easy and inexpensive development of a breadboard extension module. These satellite boards can access all of the GPIO and analog signals. The alignment of the connectors and the pin out can be found in [Section 5](#).

4.6 Device Migration Path

Applications developed on the LAUNCHXL-F28027 can easily be migrated to any of these lower cost devices in the F2802x family:

Part Number	Description
TMS320F28027 ⁽¹⁾	32-bit Real Time Microcontroller, 60 MHz, 32K Flash, 6K RAM, 4 HRPWM
TMS320F28026	32-bit Real Time Microcontroller, 60 MHz, 16K Flash, 6K RAM, 4 HRPWM
TMS320F28023	32-bit Real Time Microcontroller, 50 MHz, 32K Flash, 6K RAM, 4 HRPWM
TMS320F28022	32-bit Real Time Microcontroller, 50 MHz, 16K Flash, 6K RAM, 4 HRPWM
TMS320F28021	32-bit Real Time Microcontroller, 40 MHz, 32K Flash, 5K RAM
TMS320F28020	32-bit Real Time Microcontroller, 40 MHz, 16K Flash, 3K RAM
TMS320F280200	32-bit Real Time Microcontroller, 40 MHz, 8K Flash, 3K RAM

⁽¹⁾ This device is present on the LAUNCHXL-F28027.

5 LAUNCHXL-F28027 Hardware

5.1 Device Pin Out

Table 1 lists the pin out and pin mux options for the C2000 LaunchPad.

Table 1. C2000 LaunchPad Pin Out and Pin Mux Options

Mux Value						Mux Value			
3	2	1	0	J1 Pin	J5 Pin	0	1	2	3
			+3.3V	1	1	+5V			
			ADCINA6	2	2	GND			
TZ2	SDAA	SCIRXDA	GPIO28	3	3	ADCINA7			
TZ3	SCLA	SCITXDA	GPIO29	4	4	ADCINA3			
Rsvd	Rsvd	COMP2OUT	GPIO34	5	5	ADCINA1			
			ADCINA4	6	6	ADCINA0			
	SCITXDA	SPICLK	GPIO18	7	7	ADCINB1			
			ADCINA2	8	8	ADCINB3			
			ADCINB2	9	9	ADCINB7			
			ADCINB4	10	10	NC			
3	2	1	0	J6 Pin	J2 Pin	0	1	2	3
Rsvd	Rsvd	EPWM1A	GPIO0	1	1	GND			
COMP1OUT	Rsvd	EPWM1B	GPIO1	2	2	GPIO19	SPISTEA	SCIRXDA	ECAP1
Rsvd	Rsvd	EPWM2A	GPIO2	3	3	GPIO12	TZ1	SCITXDA	Rsvd
COMP2OUT	Rsvd	EPWM2B	GPIO3	4	4	NC			
Rsvd	Rsvd	EPWM3A	GPIO4	5	5	RESET#			
ECAP1	Rsvd	EPWM3B	GPIO5	6	6	GPIO16/32	SPISIMOA/ SDAA	Rsvd/ EPWMSYNCI	TZ2/ ADCSOCA
TZ2/ ADCSOCA	Rsvd/ EPWMSYNCI	SPISIMOA/ SDAA	GPIO16/32	7	7	GPIO17/33	SPISOMIA/ SCLA	Rsvd/ EPWMSYNCO	TZ3/ ADCSOCB
TZ3/ ADCSOCB	Rsvd/ EPWMSYNCO	SPISOMIA/ SCLA	GPIO17/33	8	8	GPIO6	EPWM4A	EPWMSYNCI	EPWMSYNCO
			NC	9	9	GPIO7	EPWM4B	SCIRXDA	Rsvd
			NC	10	10	ADCINB6			

5.2 Schematics

Figure 2 and Figure 3 show the C2000 LaunchPad schematics sheets.

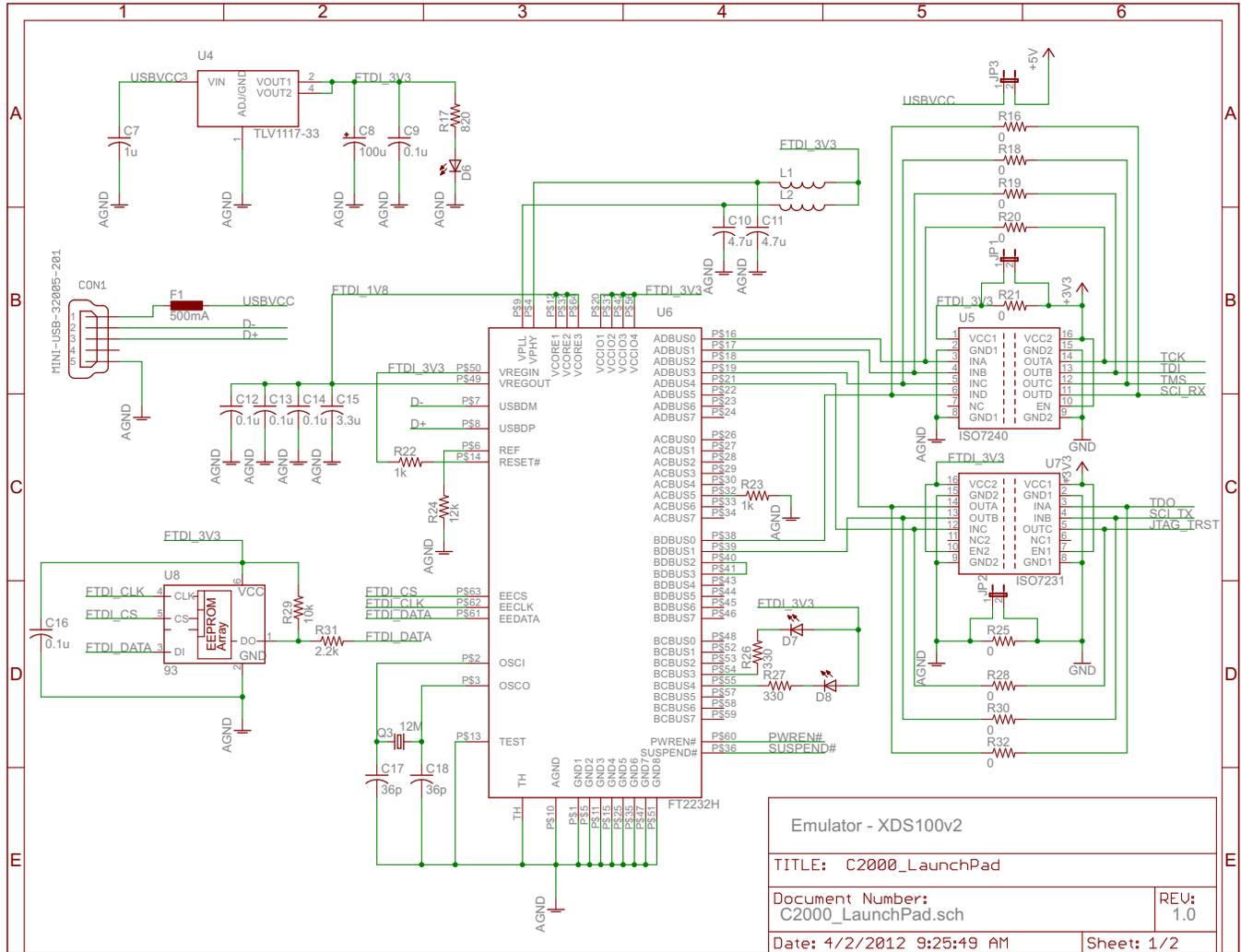


Figure 2. C2000 LaunchPad Schematic—Sheet 1 of 2

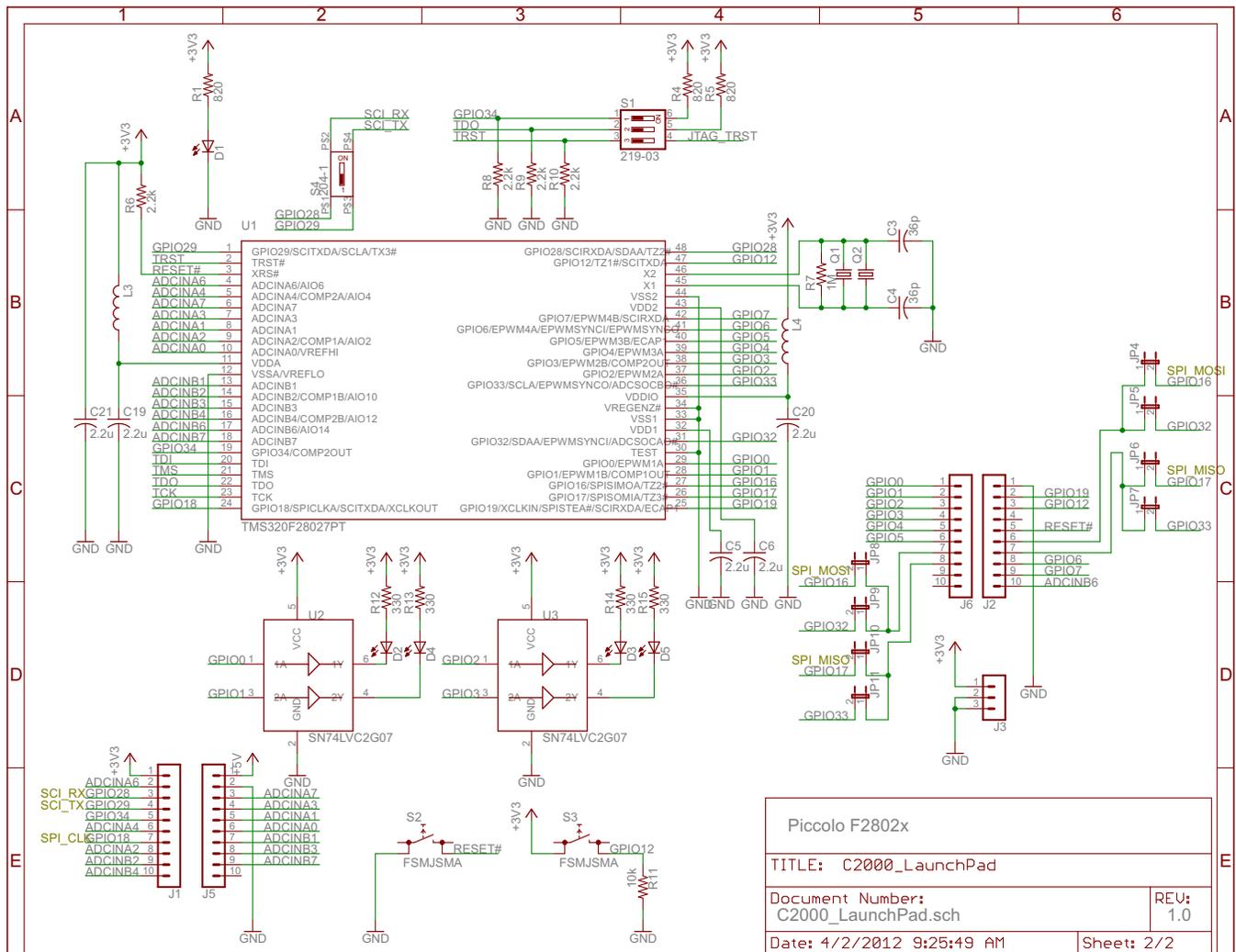


Figure 3. C2000 LaunchPad Schematic—Sheet 2 of 2

5.3 PCB Layout

Figure 4, Figure 5, and Figure 6 show the LAUNCHXL-F28027 PCB layout.

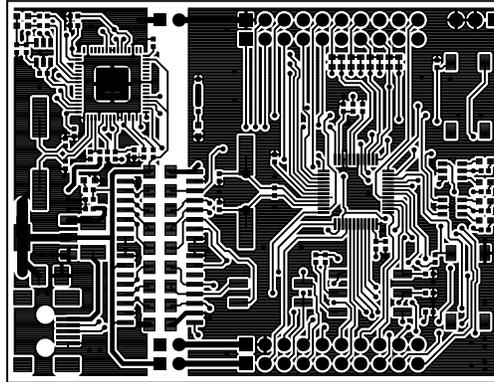


Figure 4. LAUNCHXL-F28027 PCB Layout—Top Layer

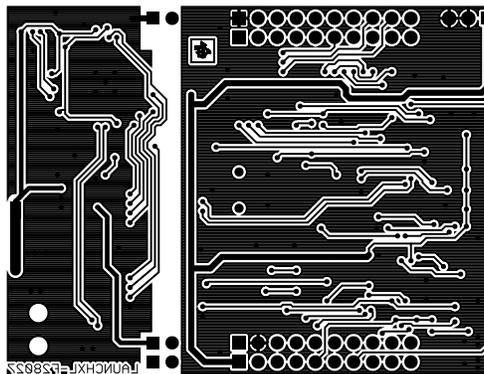


Figure 5. LAUNCHXL-F28027 PCB Layout—Bottom Layer

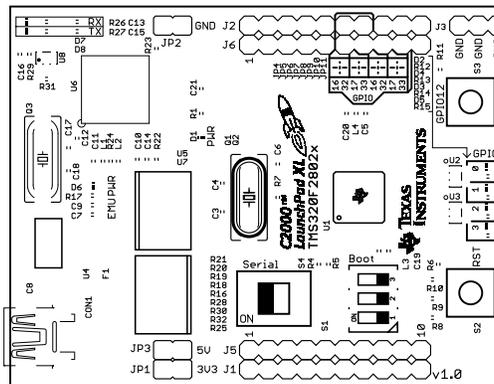


Figure 6. LAUNCHXL-F28027 PCB Layout—Silkscreen Image

5.4 Bill of Materials (BOM)

Table 2 lists the LAUNCHXL-F28027 bill of materials.

Table 2. LAUNCHXL-F28027 Bill of Materials

Reference	Quantity per Board	Description
R12, R13, R14, R15, R26, R27	6	RES 330 Ω 1/10W 5% 0402 SMD
R1, R4, R5, R17	4	RES 820 Ω 1/10W 5% 0402 SMD
R22, R23	2	RES 1.0K Ω 1/10W 5% 0402 SMD
R6, R8, R9, R10, R31	5	RES 2.2K Ω 1/10W 5% 0402 SMD
R11, R29	2	RES 10K Ω 1/10W 5% 0402 SMD
R24	1	RES 12K Ω 1/16W .5% 0402 SMD
R7	1	RES 1.0M Ω 1/10W 5% 0402 SMD
R16, R18, R19, R20, R21, R25, R28, R30, R32	9	RES 0.0 Ω 1/4W 1206 SMD
L1, L2	2	FERRITE BEAD 600 Ω 0402
L3	1	FERRITE BEAD 220 Ω 0402
L4	1	FERRITE CHIP 60 Ω 1.5A 0402
C9, C12, C13, C14, C16	5	CAP .10 μF 16 V CERAMIC Y5V 0402
C7	1	CAP CER 1.0 μF 6.3 V X5R 20% 0402
C5, C6, C19, C20, C21	5	CAP CER 2.2 μF 6.3 V 20% X5R 0402
C15	1	CAP CER 3.3 μF 4.0 V X5R 0402
C10, C11	2	CAP CER 4.7 μF 4 V X5R 0402
C3, C4	2	CAP CER 36PF 50 V C0G 0402
C17, C18	2	CAP CER 36PF 50 V C0G 0402
C8	1	CAP TANTALUM 100 μF 6.3 V 10% SMD
F1	1	PTC RESETTABLE .50A 15 V 1812
S1	1	SWITCH DIP 3POS TOP SLIDE SMT
S4	1	SWITCH DIP DPST 1POS SMT
S2, S3	2	SW TACT SPST-NO MOM 160GF SMD
Q1, Q2	1	Crystal
Q3	1	CRYSTAL 12.0000 MHZ 18PF SMD
D6	1	LED RED HIGH BRIGHT ESS SMD
D1	1	LED GREEN HIGH BRIGHT ESS SMD
D2, D3, D4, D5, D7, D8	6	LED BLUE HIGH BRIGHT ESS SMD
JP1, JP2, JP3	3	BERGSTIK II .100" SR STRAIGHT
J1 and J5, J2 and J6	2	CONN HEADER .100 DUAL STR 20POS
J3	1	CONN HEADER .100 SNGL STR 3POS
CON1	1	CONN RECEIPT MINI-USB TYPE B SMT
U4	1	IC LDO REG 800MA 3.3 V SOT223-4
U2, U3	2	IC BUFF/DVR DL NON-INV SOT236
U5	1	ISOLAT DGTL 2.5 KVRMS 4CH 16-SOIC
U7	1	ISOLAT DGTL 3 KVRMS 3CH 16-SOIC
U6	1	IC USB HS DUAL UART and FIFO 64-QFN
U8	1	IC EEPROM 2KBIT 3 MHZ SOT23-6
U1	1	IC MCU 32 BIT 64KB FLASH 48LQFP

6 Suggested Reading

The following documents describe the C2000 devices. Copies of these documents are available on the Internet at <http://www.ti.com/c2000> and www.ti.com/c2000-launchpad, or click on the links below:

- *TMS320F28027/28026/28023/28022/28021/28020/280200 Piccolo Microcontrollers Data Manual* ([SPRS523](#))
- *TMS320F28027/28026/28023/28022/28021/28020/2802x0 Piccolo MCU Silicon Errata* ([SPRZ292](#))
- *TMS320x2802x, 2803x Piccolo Analog-to-Digital Converter (ADC) and Comparator Reference Guide* ([SPRUGE5](#))
- *TMS320x2802x, 2803x Piccolo High Resolution Pulse Width Modulator (HRPWM) Reference Guide* ([SPRUGE8](#))
- *TMS320x2802x, 2803x Piccolo Inter-Integrated Circuit (I2C) Reference Guide* ([SPRUFZ9](#))
- *TMS320x2802x, 2803x Piccolo Enhanced Pulse Width Modulator (ePWM) Module Reference Guide* ([SPRUGE9](#))
- *TMS320x2802x/TMS320F2802xx Piccolo System Control and Interrupts Reference Guide* ([SPRUFN3](#))
- *TMS320x2802x Piccolo Boot ROM Reference Guide* ([SPRUFN6](#))
- *TMS320x2802x, 2803x Piccolo Serial Communications Interface (SCI) Reference Guide* ([SPRUGH1](#))
- *TMS320x2802x, 2803x Piccolo Enhanced Capture (eCAP) Module Reference Guide* ([SPRUFZ8](#))
- *TMS320C28x Instruction Set Simulator Technical Overview* ([SPRU608](#))
- *TMS320C28x Optimizing C/C++ Compiler v6.1 User's Guide* ([SPRU514](#))
- *TMS320C28x Assembly Language Tools v6.1 User's Guide* ([SPRU513](#))

7 Frequently Asked Questions (FAQ)

1. Can other programming and debug tools (such as an XDS510 emulator) be used with the C2000 LaunchPad?

While a user could potentially connect an external emulator to the F28027 device present on the LaunchPad, it would require some rework of the board. It is recommended that users who want to use an external emulator purchase a controlCard and docking station that includes an external JTAG connector.

2. What versions of Code Composer Studio can be used to develop software for the C2000 LaunchPad?
It is highly recommend that novice users develop applications with Code Composer Studio v5. The drivers, examples, and other associated software are tailored to make the user experience as smooth as possible in Code Composer Studio v5. However, there is nothing to prevent a user from creating projects in Code Composer Studio v3 or v4 with the source files available in controlSUITE. Keep in mind that all the projects for the C2000 LaunchPad are Code Composer Studio v5 projects and will not import into Code Composer Studio v3 or v4. Only expert users should attempt to use the LaunchPad with Code Composer Studio v3 or v4.
3. Why can't I connect to the LaunchPad in Code Composer Studio?

There are a number of things that could cause this and they all have an easy fix.

- Is S1 switch 3 in the down position?

This is the TRST pin which enables and disables JTAG functionality on the chip. This switch must be in the up position for the emulator to be able to connect.

- Are both power LEDs lit?

The board has two power domains because of the isolated JTAG interface. For low-voltage application development, JTAG isolation is not needed and the power domains can be combined to allow for convenience (that is, the board can be powered completely through the USB). Ensure that jumpers are placed on the posts of JP1, JP2, and JP3.

- Are drivers correctly installed for the XDS100v2 present on the LaunchPad?

Right click on *My Computer* and select properties. Navigate to the *Hardware* tab in the dialog box and open the device manager. Scroll to the bottom of the list and expand the *USB Serial Bus controllers* item. Are there two entries for *TI XDS100 Channel A/B*? If not, try unplugging and replugging in the board. Does Windows give you any messages in the system tray? In Device Manger, do either of the entries have a yellow exclamation mark over their icon? If so, try reinstalling the drivers.

4. Why is the serial connection not working?

There are a few things that could cause this and they are easy to fix.

- Is S4 in the up position?

S4 connects the F28027 device serial peripheral to the XDS100 serial port, so this switch must be turned on (up) for serial connectivity to function.

- Are you using the correct COM port?

Right click on *My Computer* and select properties. Navigate to the *Hardware* tab in the dialog box and open the device manager. Scroll to *Ports (COM & LPT)* and expand this entry. Is there a USB Serial Port listed? If so, read the COM number to the right of the entry; this is the COM number you should be using.

- Are you using the correct baud rate?

Most, if not all, of the examples are configured for a baud rate of 115200 when the CPU is running at 60 MHz. If you have changed the PLL settings or written your own application you may have to recalculate the baud rate for your specific application. For information on how to do this, see the [TMS320x2802x, 2803x Piccolo Serial Communications Interface \(SCI\) Reference Guide \(SPRUGH1\)](#).

EVALUATION BOARD/KIT/MODULE (EVM) ADDITIONAL TERMS

Texas Instruments (TI) provides the enclosed Evaluation Board/Kit/Module (EVM) under the following conditions:

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING LIMITED WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE. EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please visit www.ti.com/esh or contact TI.

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REGULATORY COMPLIANCE INFORMATION

As noted in the EVM User's Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs **not** subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

General Statement for EVMs including a radio

User Power/Frequency Use Obligations: This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

For EVMs annotated as IC – INDUSTRY CANADA Compliant

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

Concerning EVMs including radio transmitters

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concerning EVMs including detachable antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

Concernant les EVMs avec appareils radio

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

【Important Notice for Users of this Product in Japan】

This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

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<http://www.tij.co.jp>

EVALUATION BOARD/KIT/MODULE (EVM) WARNINGS, RESTRICTIONS AND DISCLAIMERS

For Feasibility Evaluation Only, in Laboratory/Development Environments. Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
3. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

Certain Instructions. It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

Agreement to Defend, Indemnify and Hold Harmless. You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

Safety-Critical or Life-Critical Applications. If you intend to evaluate the components for possible use in safety critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, such as devices which are classified as FDA Class III or similar classification, then you must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.

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TI has specifically designated certain components which meet ISO/TS16949 requirements, mainly for automotive use. Components which have not been so designated are neither designed nor intended for automotive use; and TI will not be responsible for any failure of such components to meet such requirements.

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